

IFW

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of: *Jae Han CHA*

Serial No.: 10/612,074 Group Art Unit: 2823

Filed: July 3, 2003 Examiner: Estrada, Michelle

For: METHOD OF FORMING AN ISOLATION FILM IN A SEMICONDUCTOR DEVICE

TRANSMITTAL

Honorable Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

May 24, 2004

Sir:

Transmitted herewith is an Amendment.

The fee has been calculated as shown below:

Claims Remaining After Amendment	Highest Number Previously Paid For	Present Extra Fee	Small Entity Rate Addit. (or) Fee	Other Than A Small Entity Rate Addit. Fee
Total 14	- 20 =	0	x 09 = \$	x 18 = \$
Indep. 02	- 03 =	0	x 43 = \$	x 86 = \$
	First Presentation of Multiple Dependent Claims	+145 = \$		+ 290 = \$
	Total Additional Fee	\$		\$

____ Payment by credit card (Form PTO-2038) in the amount of \$_____ is enclosed for:

XXXX If a Petition for Extension of Time is necessary and the Petition and/or the payment of the fee is not enclosed, this will act as the Petition and applicant herewith petitions the Commissioner to extend the time for response and charge any fees necessary under 37 CFR 1.17 (a)(1)-(5) to Deposit Account No. 06-1358. The Commissioner is also authorized to charge payment of any other additional fees associated with this communication or credit any overpayment to Deposit Account No. 06-1358. A duplicate copy of this sheet is attached.

Respectfully submitted,

JACOBSON HOLMAN PLLC

By:

Yoon S. Ham
Reg. No. 45,307

The Jenifer Building
400 Seventh Street, N.W.
Washington, D.C. 20004-2201
Telephone: (202) 638-6666
Atty. Docket: P68962US0
YSH:dj



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of: Jae Han CHA

Serial No.: 10/612,074

Group Art Unit: 2823

Filed: July 3, 2003

Examiner: Estrada, Michelle

For: METHOD OF FORMING AN ISOLATION FILM IN A SEMICONDUCTOR
DEVICE

* * * * *

AMENDMENT

Honorable Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

May 24, 2004

Sir:

Responsive to the Office Action mailed February 24, 2004
(Paper No. 20040218), kindly enter the following amendments and
remarks.